

# 74HC107; 74HCT107

Dual JK flip-flop with reset; negative-edge trigger

Rev. 5 — 30 November 2015

Product data sheet

## 1. General description

The 74HC107; 74HCT107 is a dual negative edge triggered JK flip-flop featuring individual J and K inputs, clock ( $\overline{CP}$ ) and reset ( $\overline{R}$ ) inputs and complementary Q and  $\overline{Q}$  outputs. The reset is an asynchronous active LOW input and operates independently of the clock input. The J and K inputs control the state changes of the flip-flops as described in the mode select function table. The J and K inputs must be stable one set-up time prior to the HIGH-to-LOW clock transition for predictable operation. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

## 2. Features and benefits

- Complies with JEDEC standard no. 7A
- Input levels:
  - ◆ The 74HC107: CMOS levels
  - ◆ The 74HCT107: TTL levels
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and from  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$

## 3. Ordering information

Table 1. Ordering information

| Type number | Package   |         |  |          |
|-------------|---|---------|--|----------|
|             | Temperature range   | Name    | Description  | Version  |
| 74HC107D    | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | SO14    | plastic small outline package; 14 leads; body width 3.9 mm             | SOT108-1 |
| 74HCT107D   |   |         |  |          |
| 74HC107DB   | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | SSOP14  | plastic shrink small outline package; 14 leads; body width 5.3 mm      | SOT337-1 |
| 74HC107PW   | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |



## 4. Functional diagram

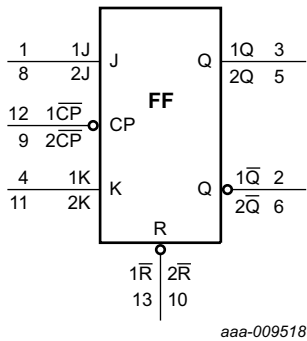


Fig 1. Logic symbol

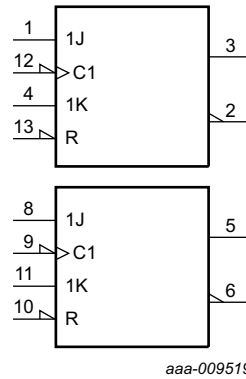


Fig 2. IEC logic symbol

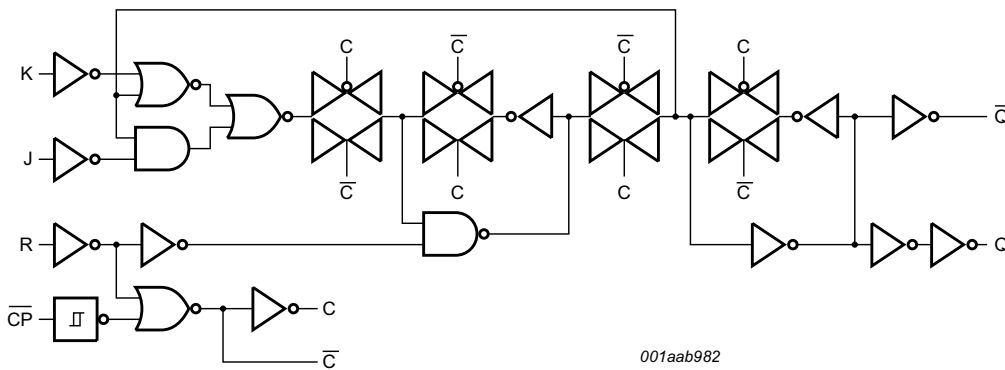


Fig 3. Logic diagram (one flip-flop)

## 5. Pinning information

### 5.1 Pinning

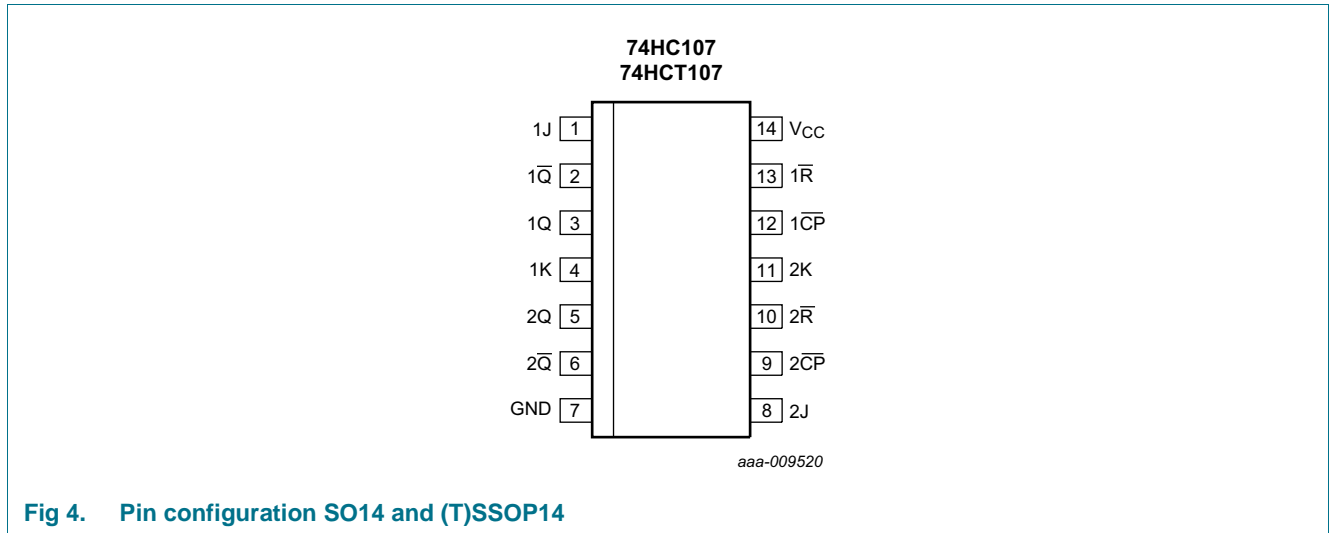


Fig 4. Pin configuration SO14 and (T)SSOP14

### 5.2 Pin description

Table 2. Pin description

| Symbol          | Pin    | Description                              |
|-----------------|--------|--|
| 1J, 2J          | 1, 8   | synchronous J input                      |
| 1Q̄, 2Q̄        | 2, 6   | complement output                        |
| 1Q, 2Q          | 3, 5   | true output                              |
| 1K, 2K          | 4, 11  | synchronous K input                      |
| 1CP̄, 2CP̄      | 12, 9  | clock input (HIGH-to-LOW edge-triggered) |
| 1R̄, 2R̄        | 13, 10 | asynchronous reset input (active LOW)    |
| GND             | 7      | ground (0 V)                             |
| V <sub>CC</sub> | 14     | supply voltage                           |

## 6. Functional description

Table 3. Function table<sup>[1]</sup>

| Input |    |   |   | Output |    | Operating mode     |
|-------|----|---|---|--------|----|--------------------|
| R     | CP | J | K | Q      | Q̄ |                    |
| L     | X  | X | X | L      | H  | asynchronous reset |
| H     | ↓  | h | h | q̄     | q  | toggle             |
| H     | ↓  | l | h | L      | H  | load 0 (reset)     |
| H     | ↓  | h | l | H      | L  | load 1 (set)       |
| H     | ↓  | l | l | q      | q̄ | hold (no change)   |

- [1] H = HIGH voltage level;  
 h = HIGH voltage level one set-up time prior to the HIGH-to-LOW clock transition;  
 L = LOW voltage level;  
 l = LOW voltage level one set-up time prior to the HIGH-to-LOW clock transition;  
 q = state of referenced output one set-up time prior to the HIGH-to-LOW clock transition;  
 X = don't care;  
 ↓ = HIGH-to-LOW clock transition.

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   | Min  | Max  | Unit |
|------------------|-------------------------|--|------|------|------|
| V <sub>CC</sub>  | supply voltage          |  | -0.5 | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < -0.5 V or V <sub>I</sub> > V <sub>CC</sub> + 0.5 V <sup>[1]</sup> | -    | ±20  | mA   |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> < -0.5 V or V <sub>O</sub> > V <sub>CC</sub> + 0.5 V <sup>[1]</sup> | -    | ±20  | mA   |
| I <sub>O</sub>   | output current          | V <sub>O</sub> = -0.5 V to V <sub>CC</sub> + 0.5 V                                 | -    | ±25  | mA   |
| I <sub>CC</sub>  | supply current          |  | -    | 50   | mA   |
| I <sub>GND</sub> | ground current          |  | -50  | -    | mA   |
| T <sub>stg</sub> | storage temperature     |  | -65  | +150 | °C   |
| P <sub>tot</sub> | total power dissipation | T <sub>amb</sub> = -40 °C to +125 °C   |      |      |      |
|                  |                         | SO14 package <sup>[2]</sup>  | -    | 500  | mW   |
|                  |                         | (T)SSOP14 package <sup>[3]</sup>   | -    | 500  | mW   |

- [1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
 [2] P<sub>tot</sub> derates linearly with 8 mW/K above 70 °C.  
 [3] P<sub>tot</sub> derates linearly with 5.5 mW/K above 60 °C.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

Voltages are referenced to GND (ground = 0 V)

| Symbol           | Parameter                           | Conditions              | 74HC107 |      |                 | 74HCT107 |      |                 | Unit |
|------------------|-------------------------------------|-------------------------|---------|------|-----------------|----------|------|-----------------|------|
|                  |                                     |                         | Min     | Typ  | Max             | Min      | Typ  | Max             |      |
| V <sub>CC</sub>  | supply voltage                      |                         | 2.0     | 5.0  | 6.0             | 4.5      | 5.0  | 5.5             | V    |
| V <sub>I</sub>   | input voltage                       |                         | 0       | -    | V <sub>CC</sub> | 0        | -    | V <sub>CC</sub> | V    |
| V <sub>O</sub>   | output voltage                      |                         | 0       | -    | V <sub>CC</sub> | 0        | -    | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature                 |                         | -40     | +25  | +125            | -40      | +25  | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 2.0 V | -       | -    | 625             | -        | -    | -               | ns/V |
|                  |                                     | V <sub>CC</sub> = 4.5 V | -       | 1.67 | 139             | -        | 1.67 | 139             | ns/V |
|                  |                                     | V <sub>CC</sub> = 6.0 V | -       | -    | 83              | -        | -    | -               | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions   | 25 °C |      |      | -40 °C to +85 °C |      | -40 °C to +125 °C |      | Unit |
|-----------------|---------------------------|--|-------|------|------|------------------|------|-------------------|------|------|
|                 |                           |  | Min   | Typ  | Max  | Min              | Max  | Min               | Max  |      |
| <b>74HC107</b>  |                           |  |       |      |      |                  |      |                   |      |      |
| V <sub>IH</sub> | HIGH-level input voltage  | V <sub>CC</sub> = 2.0 V  | 1.5   | 1.2  | -    | 1.5              | -    | 1.5               | -    | V    |
|                 |                           | V <sub>CC</sub> = 4.5 V  | 3.15  | 2.4  | -    | 3.15             | -    | 3.15              | -    | V    |
|                 |                           | V <sub>CC</sub> = 6.0 V  | 4.2   | 3.2  | -    | 4.2              | -    | 4.2               | -    | V    |
| V <sub>IL</sub> | LOW-level input voltage   | V <sub>CC</sub> = 2.0 V  | -     | 0.8  | 0.5  | -                | 0.5  | -                 | 0.5  | V    |
|                 |                           | V <sub>CC</sub> = 4.5 V  | -     | 2.1  | 1.35 | -                | 1.35 | -                 | 1.35 | V    |
|                 |                           | V <sub>CC</sub> = 6.0 V  | -     | 2.8  | 1.8  | -                | 1.8  | -                 | 1.8  | V    |
| V <sub>OH</sub> | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |       |      |      |                  |      |                   |      |      |
|                 |                           | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V                                       | 1.9   | 2.0  | -    | 1.9              | -    | 1.9               | -    | V    |
|                 |                           | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V                                       | 4.4   | 4.5  | -    | 4.4              | -    | 4.4               | -    | V    |
|                 |                           | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V                                       | 5.9   | 6.0  | -    | 5.9              | -    | 5.9               | -    | V    |
|                 |                           | I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V                                      | 3.98  | 4.32 | -    | 3.84             | -    | 3.7               | -    | V    |
| V <sub>OL</sub> | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |       |      |      |                  |      |                   |      |      |
|                 |                           | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V  | -     | 0    | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                 |                           | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V  | -     | 0    | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                 |                           | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V  | -     | 0    | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                 |                           | I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V                                       | -     | 0.15 | 0.26 | -                | 0.33 | -                 | 0.4  | V    |
| I <sub>l</sub>  | input leakage current     | V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 6.0 V                       | -     | -    | ±0.1 | -                | ±1.0 | -                 | ±1.0 | μA   |
|                 |                           | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 6.0 V | -     | -    | 4.0  | -                | 40   | -                 | 80   | μA   |

**Table 6. Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                 | Conditions  | 25 °C |      |      | -40 °C to +85 °C |      | -40 °C to +125 °C |      | Unit |
|------------------|---------------------------|---|-------|------|------|------------------|------|-------------------|------|------|
|                  |                           |   | Min   | Typ  | Max  | Min              | Max  | Min               | Max  |      |
| C <sub>I</sub>   | input capacitance         |   | -     | 3.5  | -    |                  |      |                   |      | pF   |
| <b>74HCT107</b>  |                           |   |       |      |      |                  |      |                   |      |      |
| V <sub>IH</sub>  | HIGH-level input voltage  | V <sub>CC</sub> = 4.5 V to 5.5 V  | 2.0   | 1.6  | -    | 2.0              | -    | 2.0               | -    | V    |
| V <sub>IL</sub>  | LOW-level input voltage   | V <sub>CC</sub> = 4.5 V to 5.5 V  | -     | 1.2  | 0.8  | -                | 0.8  | -                 | 0.8  | V    |
| V <sub>OH</sub>  | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V   |       |      |      |                  |      |                   |      |      |
|                  |                           | I <sub>O</sub> = -20 μA   | 4.4   | 4.5  | -    | 4.4              | -    | 4.4               | -    | V    |
|                  |                           | I <sub>O</sub> = -4 mA  | 3.98  | 4.32 | -    | 3.84             | -    | 3.7               | -    | V    |
| V <sub>OL</sub>  | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V   |       |      |      |                  |      |                   |      |      |
|                  |                           | I <sub>O</sub> = 20 μA  | -     | 0    | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                  |                           | I <sub>O</sub> = 4.0 mA   | -     | 0.16 | 0.26 | -                | 0.33 | -                 | 0.4  | V    |
| I <sub>I</sub>   | input leakage current     | V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 5.5 V  | -     | -    | ±0.1 | -                | ±1.0 | -                 | ±1.0 | μA   |
| I <sub>CC</sub>  | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 5.5 V  | -     | -    | 4.0  | -                | 40   | -                 | 80   | μA   |
| ΔI <sub>CC</sub> | additional supply current | per input pin; V <sub>I</sub> = V <sub>CC</sub> - 2.1 V; I <sub>O</sub> = 0 A; other inputs at V <sub>CC</sub> or GND; V <sub>CC</sub> = 4.5 V to 5.5 V |       |      |      |                  |      |                   |      |      |
|                  |                           | pin nCP, nJ   | -     | 100  | 360  | -                | 450  | -                 | 490  | μA   |
|                  |                           | pin nR  | -     | 65   | 234  | -                | 293  | -                 | 319  | μA   |
|                  |                           | pin nK  | -     | 60   | 216  | -                | 270  | -                 | 294  | μA   |
| C <sub>I</sub>   | input capacitance         |   | -     | 3.5  | -    | -                | -    | -                 | -    | pF   |

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit, see [Figure 7](#)

| Symbol                          | Parameter         | Conditions  | 25 °C |     |     | -40 °C to +85 °C |     | -40 °C to +125 °C |     | Unit |
|---------------------------------|-------------------|---|-------|-----|-----|------------------|-----|-------------------|-----|------|
|                                 |                   |   | Min   | Typ | Max | Min              | Max | Min               | Max |      |
| <b>74HC107</b>                  |                   |   |       |     |     |                  |     |                   |     |      |
| $t_{pd}$                        | propagation delay | $\overline{nCP}$ to nQ; see <a href="#">Figure 5</a> <sup>[1]</sup>   |       |     |     |                  |     |                   |     |      |
|                                 |                   | $V_{CC} = 2.0$ V  | -     | 52  | 160 | -                | 200 | -                 | 240 | ns   |
|                                 |                   | $V_{CC} = 4.5$ V  | -     | 19  | 32  | -                | 40  | -                 | 48  | ns   |
|                                 |                   | $V_{CC} = 5.0$ V; $C_L = 15$ pF                                       | -     | 16  | -   | -                | -   | -                 | -   | ns   |
|                                 |                   | $V_{CC} = 6.0$ V  | -     | 15  | 27  | -                | 34  | -                 | 41  | ns   |
|                                 |                   | $\overline{nCP}$ to $\overline{nQ}$ ; see <a href="#">Figure 5</a>    |       |     |     |                  |     |                   |     |      |
|                                 |                   | $V_{CC} = 2.0$ V  | -     | 52  | 160 | -                | 200 | -                 | 240 | ns   |
|                                 |                   | $V_{CC} = 4.5$ V  | -     | 19  | 32  | -                | 40  | -                 | 48  | ns   |
|                                 |                   | $V_{CC} = 5.0$ V; $C_L = 15$ pF                                       | -     | 16  | -   | -                | -   | -                 | -   | ns   |
|                                 |                   | $V_{CC} = 6.0$ V  | -     | 15  | 27  | -                | 34  | -                 | 41  | ns   |
|                                 |                   | $\overline{nR}$ to nQ, $\overline{nQ}$ ; see <a href="#">Figure 6</a> |       |     |     |                  |     |                   |     |      |
|                                 |                   | $V_{CC} = 2.0$ V  | -     | 52  | 155 | -                | 195 | -                 | 235 | ns   |
|                                 |                   | $V_{CC} = 4.5$ V  | -     | 19  | 31  | -                | 39  | -                 | 47  | ns   |
| $V_{CC} = 5.0$ V; $C_L = 15$ pF | -                 | 16  | -     | -   | -   | -                | -   | ns                |     |      |
| $V_{CC} = 6.0$ V                | -                 | 15  | 26    | -   | 33  | -                | 40  | ns                |     |      |
| $t_t$                           | transition time   | nQ, $\overline{nQ}$ ; see <a href="#">Figure 5</a> <sup>[2]</sup>     |       |     |     |                  |     |                   |     |      |
|                                 |                   | $V_{CC} = 2.0$ V  | -     | 19  | 75  | -                | 95  | -                 | 110 | ns   |
|                                 |                   | $V_{CC} = 4.5$ V  | -     | 7   | 15  | -                | 19  | -                 | 22  | ns   |
|                                 |                   | $V_{CC} = 6.0$ V  | -     | 6   | 13  | -                | 16  | -                 | 19  | ns   |
| $t_w$                           | pulse width       | $\overline{nCP}$ input, HIGH or LOW; see <a href="#">Figure 5</a>     |       |     |     |                  |     |                   |     |      |
|                                 |                   | $V_{CC} = 2.0$ V  | 80    | 22  | -   | 100              | -   | 120               | -   | ns   |
|                                 |                   | $V_{CC} = 4.5$ V  | 16    | 8   | -   | 20               | -   | 24                | -   | ns   |
|                                 |                   | $V_{CC} = 6.0$ V  | 14    | 6   | -   | 17               | -   | 20                | -   | ns   |
|                                 |                   | $\overline{nR}$ input, HIGH or LOW; see <a href="#">Figure 6</a>      |       |     |     |                  |     |                   |     |      |
|                                 |                   | $V_{CC} = 2.0$ V  | 80    | 22  | -   | 100              | -   | 120               | -   | ns   |
|                                 |                   | $V_{CC} = 4.5$ V  | 16    | 8   | -   | 20               | -   | 24                | -   | ns   |
| $V_{CC} = 6.0$ V                | 14                | 6   | -     | 17  | -   | 20               | -   | ns                |     |      |
| $t_{rec}$                       | recovery time     | $\overline{nR}$ to $\overline{nCP}$ ; see <a href="#">Figure 6</a>    |       |     |     |                  |     |                   |     |      |
|                                 |                   | $V_{CC} = 2.0$ V  | 60    | 19  | -   | 75               | -   | 90                | -   | ns   |
|                                 |                   | $V_{CC} = 4.5$ V  | 12    | 7   | -   | 15               | -   | 18                | -   | ns   |
|                                 |                   | $V_{CC} = 6.0$ V  | 20    | 6   | -   | 13               | -   | 15                | -   | ns   |
| $t_{su}$                        | set-up time       | nJ, nK to $\overline{nCP}$ ; see <a href="#">Figure 5</a>             |       |     |     |                  |     |                   |     |      |
|                                 |                   | $V_{CC} = 2.0$ V  | 100   | 22  | -   | 125              | -   | 150               | -   | ns   |
|                                 |                   | $V_{CC} = 4.5$ V  | 20    | 8   | -   | 25               | -   | 30                | -   | ns   |
|                                 |                   | $V_{CC} = 6.0$ V  | 17    | 6   | -   | 21               | -   | 26                | -   | ns   |

**Table 7. Dynamic characteristics ...continued**  
 GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit, see [Figure 7](#)

| Symbol          | Parameter                       | Conditions   | 25 °C |     |     | -40 °C to +85 °C |     | -40 °C to +125 °C |     | Unit |
|-----------------|---------------------------------|--|-------|-----|-----|------------------|-----|-------------------|-----|------|
|                 |                                 |  | Min   | Typ | Max | Min              | Max | Min               | Max |      |
| $t_h$           | hold time                       | nJ, nK to $\overline{nCP}$ ; see <a href="#">Figure 5</a>                |       |     |     |                  |     |                   |     |      |
|                 |                                 | $V_{CC} = 2.0$ V   | 3     | -6  | -   | 3                | -   | 3                 | -   | ns   |
|                 |                                 | $V_{CC} = 4.5$ V   | 3     | -2  | -   | 3                | -   | 3                 | -   | ns   |
|                 |                                 | $V_{CC} = 6.0$ V   | 3     | -2  | -   | 3                | -   | 3                 | -   | ns   |
| $f_{max}$       | maximum frequency               | $\overline{nCP}$ input; see <a href="#">Figure 5</a>                     |       |     |     |                  |     |                   |     |      |
|                 |                                 | $V_{CC} = 2.0$ V   | 6     | 23  | -   | 4.8              | -   | 4.0               | -   | MHz  |
|                 |                                 | $V_{CC} = 4.5$ V   | 30    | 70  | -   | 24               | -   | 20                | -   | MHz  |
|                 |                                 | $V_{CC} = 5.0$ V; $C_L = 15$ pF  | -     | 78  | -   | -                | -   | -                 | -   | MHz  |
|                 | $V_{CC} = 6.0$ V                | 35   | 85    | -   | 28  | -                | 24  | -                 | MHz |      |
| $C_{PD}$        | power dissipation capacitance   | per flip-flop; $V_I = GND$ to $V_{CC}$ <a href="#">[3]</a>               | -     | 30  | -   | -                | -   | -                 | -   | pF   |
| <b>74HCT107</b> |                                 |  |       |     |     |                  |     |                   |     |      |
| $t_{pd}$        | propagation delay               | $\overline{nCP}$ to nQ; see <a href="#">Figure 5</a> <a href="#">[1]</a> |       |     |     |                  |     |                   |     |      |
|                 |                                 | $V_{CC} = 4.5$ V   | -     | 19  | 36  | -                | 45  | -                 | 54  | ns   |
|                 |                                 | $V_{CC} = 5.0$ V; $C_L = 15$ pF  | -     | 16  | -   | -                | -   | -                 | -   | ns   |
|                 |                                 | $\overline{nCP}$ to $\overline{nQ}$ ; see <a href="#">Figure 5</a>       |       |     |     |                  |     |                   |     |      |
|                 |                                 | $V_{CC} = 4.5$ V   | -     | 21  | 36  | -                | 45  | -                 | 54  | ns   |
|                 |                                 | $V_{CC} = 5.0$ V; $C_L = 15$ pF  | -     | 18  | -   | -                | -   | -                 | -   | ns   |
|                 |                                 | $\overline{nR}$ to nQ, $\overline{nQ}$ ; see <a href="#">Figure 6</a>    |       |     |     |                  |     |                   |     |      |
|                 | $V_{CC} = 4.5$ V                | -  | 20    | 38  | -   | 48               | -   | 57                | ns  |      |
|                 | $V_{CC} = 5.0$ V; $C_L = 15$ pF | -  | 17    | -   | -   | -                | -   | -                 | ns  |      |
| $t_t$           | transition time                 | nQ, $\overline{nQ}$ ; see <a href="#">Figure 5</a> <a href="#">[2]</a>   |       |     |     |                  |     |                   |     |      |
|                 |                                 | $V_{CC} = 4.5$ V   | -     | 7   | 15  | -                | 19  | -                 | 22  | ns   |
| $t_w$           | pulse width                     | $\overline{nCP}$ input, HIGH or LOW; see <a href="#">Figure 5</a>        |       |     |     |                  |     |                   |     |      |
|                 |                                 | $V_{CC} = 4.5$ V   | 16    | 9   | -   | 20               | -   | 24                | -   | ns   |
|                 |                                 | $\overline{nR}$ input, HIGH or LOW; see <a href="#">Figure 6</a>         |       |     |     |                  |     |                   |     |      |
|                 | $V_{CC} = 4.5$ V                | 20   | 11    | -   | 25  | -                | 30  | -                 | ns  |      |
| $t_{rec}$       | recovery time                   | $\overline{nR}$ to $\overline{nCP}$ ; see <a href="#">Figure 6</a>       |       |     |     |                  |     |                   |     |      |
|                 |                                 | $V_{CC} = 4.5$ V   | 14    | 8   | -   | 18               | -   | 21                | -   | ns   |
| $t_{su}$        | set-up time                     | nJ, nK to $\overline{nCP}$ ; see <a href="#">Figure 5</a>                |       |     |     |                  |     |                   |     |      |
|                 |                                 | $V_{CC} = 4.5$ V   | 20    | 7   | -   | 25               | -   | 30                | -   | ns   |
| $t_h$           | hold time                       | nJ, nK to $\overline{nCP}$ ; see <a href="#">Figure 5</a>                |       |     |     |                  |     |                   |     |      |
|                 |                                 | $V_{CC} = 4.5$ V   | 5     | -2  | -   | 5                | -   | 5                 | -   | ns   |



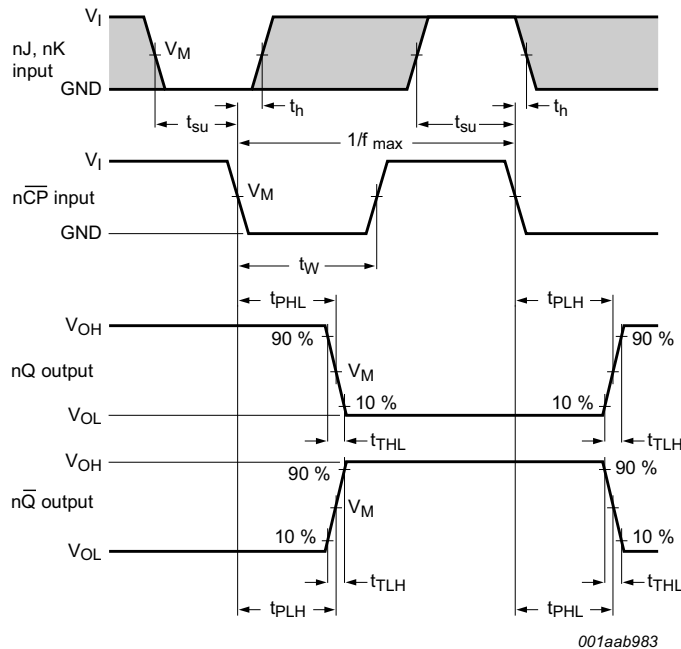
**Table 7. Dynamic characteristics ...continued**

GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit, see [Figure 7](#)

| Symbol           | Parameter                     | Conditions  | 25 °C |     |     | -40 °C to +85 °C |     | -40 °C to +125 °C |     | Unit |
|------------------|-------------------------------|---|-------|-----|-----|------------------|-----|-------------------|-----|------|
|                  |                               |   | Min   | Typ | Max | Min              | Max | Min               | Max |      |
| $f_{\text{max}}$ | maximum frequency             | nCP input; see <a href="#">Figure 5</a>   |       |     |     |                  |     |                   |     |      |
|                  |                               | $V_{\text{CC}} = 4.5 \text{ V}$   | 30    | 66  | -   | 24               | -   | 20                | -   | MHz  |
|                  |                               | $V_{\text{CC}} = 5.0 \text{ V}; C_L = 15 \text{ pF}$                                    | -     | 73  | -   | -                | -   | -                 | -   | MHz  |
| $C_{\text{PD}}$  | power dissipation capacitance | per flip-flop; $V_I = \text{GND to } V_{\text{CC}} - 1.5 \text{ V}$ <a href="#">[3]</a> | -     | 30  | -   | -                | -   | -                 | -   | pF   |

- [1]  $t_{\text{pd}}$  is the same as  $t_{\text{PHL}}, t_{\text{PLH}}$ .
- [2]  $t_t$  is the same as  $t_{\text{THL}}, t_{\text{TLH}}$ .
- [3]  $C_{\text{PD}}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).  
 $P_D = C_{\text{PD}} \times V_{\text{CC}}^2 \times f_i \times N + \sum(C_L \times V_{\text{CC}}^2 \times f_o)$  where:  
 $f_i$  = input frequency in MHz;  
 $f_o$  = output frequency in MHz;  
 $C_L$  = output load capacitance in pF;  
 $V_{\text{CC}}$  = supply voltage in V;  
 $N$  = number of inputs switching;  
 $\sum(C_L \times V_{\text{CC}}^2 \times f_o)$  = sum of outputs.

## 11. Waveforms

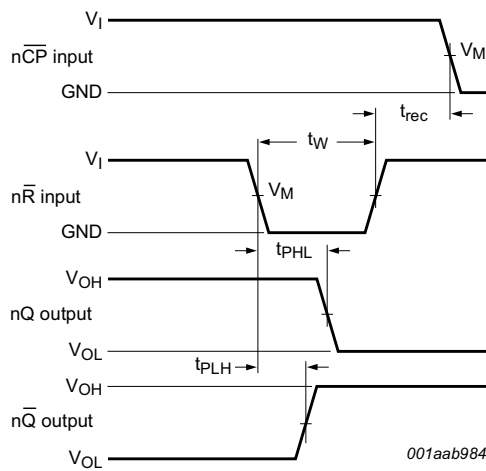


The shaded areas indicate when the input is permitted to change for predictable output performance.

Measurement points are given in [Table 8](#).

$V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output levels that occur with the output load.

**Fig 5. Clock propagation delays, pulse width, set-up and hold times, output transition times and the maximum frequency**



Measurement points are given in [Table 8](#).

$V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

**Fig 6. Reset propagation delays, pulse width and recovery time**

**Table 8. Measurement points**

| Type     | Input    |             | Output      |
|----------|----------|-------------|-------------|
|          | $V_I$    | $V_M$       | $V_M$       |
| 74HC107  | $V_{CC}$ | $0.5V_{CC}$ | $0.5V_{CC}$ |
| 74HCT107 | 3 V      | 1.3 V       | 1.3 V       |

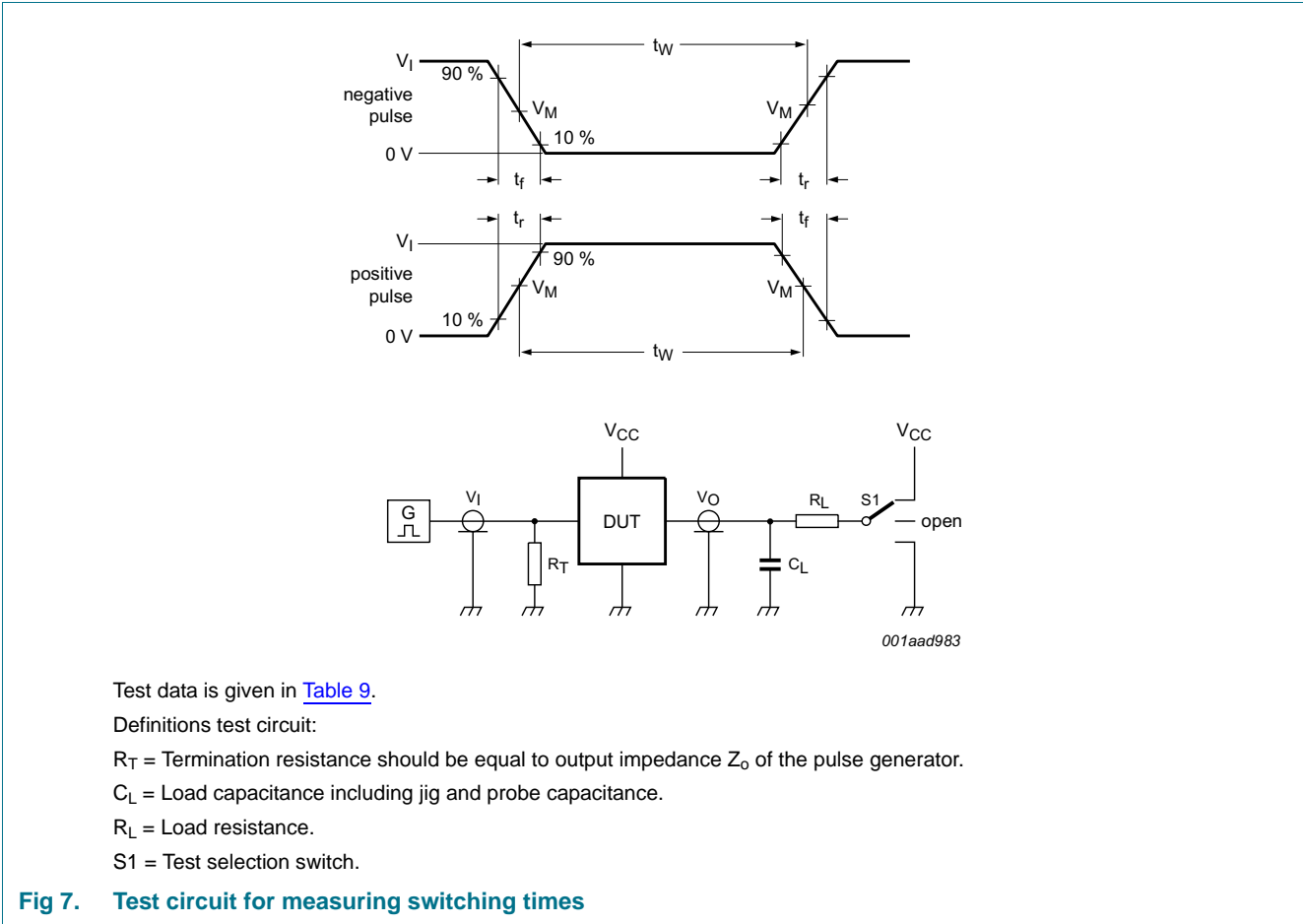


Table 9. Test data

| Type     | Input    |            | Load         |              | S1 position        |                    |                    |
|----------|----------|------------|--------------|--------------|--------------------|--------------------|--------------------|
|          | $V_I$    | $t_r, t_f$ | $C_L$        | $R_L$        | $t_{PHL}, t_{PLH}$ | $t_{PZH}, t_{PHZ}$ | $t_{PZL}, t_{PLZ}$ |
| 74HC107  | $V_{CC}$ | 6 ns       | 15 pF, 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |
| 74HCT107 | 3 V      | 6 ns       | 15 pF, 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |

12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

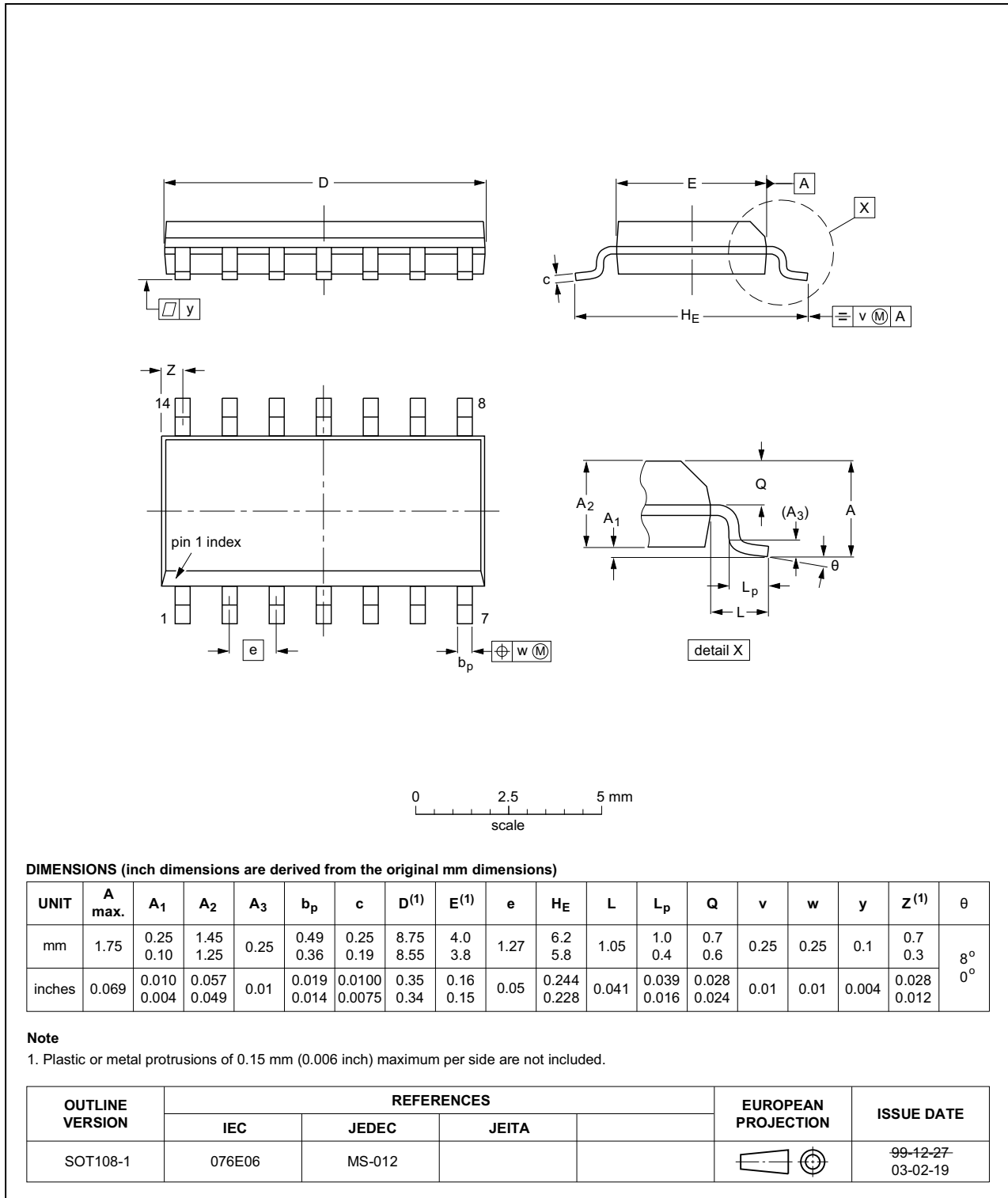


Fig 8. Package outline SOT108-1 (SO14)

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1

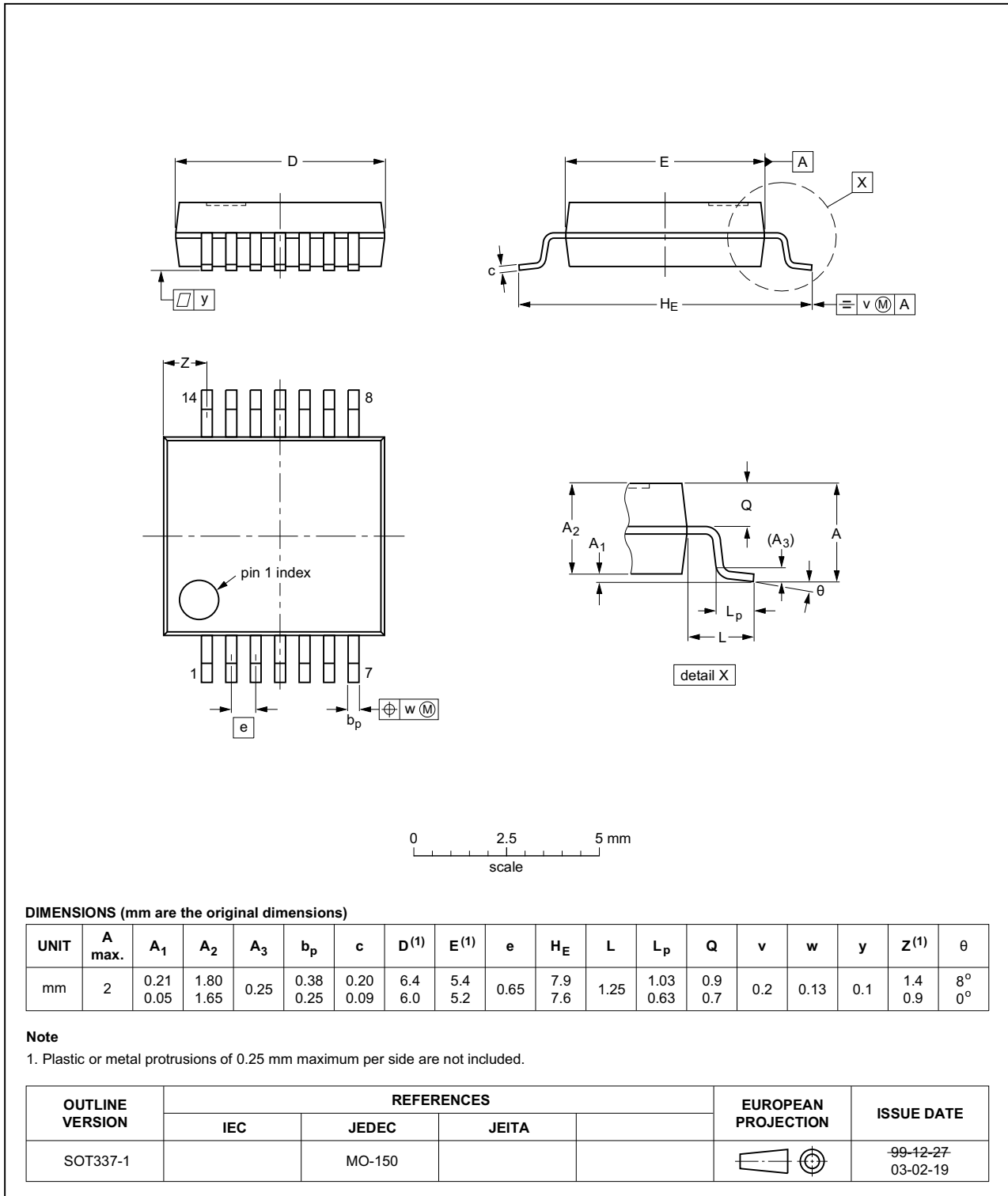


Fig 9. Package outline SOT337-1 (SSOP14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

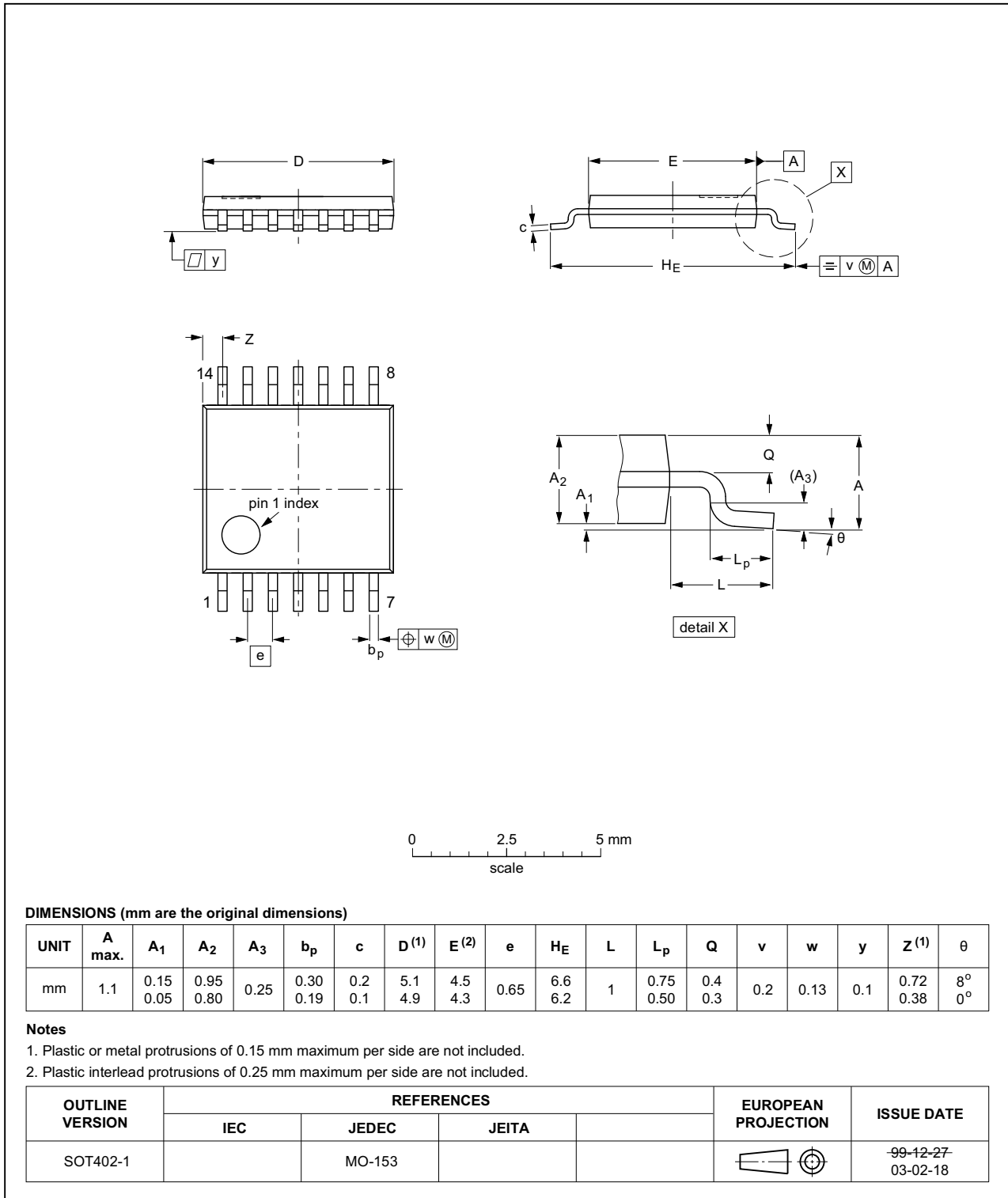


Fig 10. Package outline SOT402-1 (TSSOP14)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                             |
|---------|---|
| CMOS    | Complementary Metal-Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

## 14. Revision history

Table 11. Revision history

| Document ID         | Release date  | Data sheet status     | Change notice | Supersedes          |
|---------------------|---|-----------------------|---------------|---------------------|
| 74HC_HCT107 v.5     | 20151130  | Product data sheet    | -             | 74HC_HCT107 v.4     |
| Modifications:      | <ul style="list-style-type: none"> <li>Type numbers 74HC107N and 74HCT107N (SOT27-1) removed.</li> </ul>  |                       |               |                     |
| 74HC_HCT107 v.4     | 20150126  | Product data sheet    | -             | 74HC_HCT107 v.3     |
| Modifications:      | <ul style="list-style-type: none"> <li><a href="#">Table 7</a>: Power dissipation capacitance condition for 74HCT107 is corrected.</li> </ul>   |                       |               |                     |
| 74HC_HCT107 v.3     | 20131118  | Product data sheet    | -             | 74HC_HCT107_CNV v.2 |
| Modifications:      | <ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul> |                       |               |                     |
| 74HC_HCT107_CNV v.2 | 19901201  | Product specification | -             | -                   |

## 15. Legal information

### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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